



XLAUI / CAUI Ad Hoc Report

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1. 3 Ad Hoc telecons were held
 - Dec 5th, Dec 19th, Jan 5th
 - Material can be found at:
<http://www.ieee802.org/3/ba/public/AdHoc/nAUI/docs.html>
2. Key Topics of Interest:
 - Chip – Chip vs. Chip – Module specification
 - BER objective (1E-12 vs. 1E-15)
 - De-emphasis specification
 - Jitter Methodology and Specification
 - Stressed Receiver evaluation
 - Channel definition
3. Progress has been made, and topics will be discussed further during this meeting
 - Separate section describing how BER 1E-15 can be met
 - Separate (83B) describing chip-module compliance